

Domain Aligned Growth of Molybdenum Disulfide on Various Substrates by Chemical Vapor Deposition

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ABSTRACT

We synthesized single-layer MoS₂ atomic films on various substrates by a chemical vapor deposition method. We chose three different substrates for MoS₂ synthesis in this study; SiO₂ as an amorphous substrate, Al₂O₃ or GaN as hexagonal crystalline substrates. The lattice constant of Al₂O₃ is not well matched with that of MoS₂ whereas the lattice constant for GaN is well matched with that of MoS₂. We investigated the orientation properties of the domains of single-layer MoS₂ atomic films on these three substrates and found that MoS₂ domains synthesized on lattice-matched GaN substrate are aligned better than the other MoS₂ domains synthesized on SiO₂ or Al₂O₃ substrates. Our study may provide an insight as a route to synthesize large size, single-layer, and single-domain MoS₂ atomic films.

KEYWORDS: MoS₂, Single Domain Aligned Growth, Single Atomic Layer, Chemical Vapor Deposition.

1. INTRODUCTION

Recently, molybdenum disulfide (MoS₂) has received a great attraction in 2-dimensional atomic electronics due to its semiconducting property with intrinsic band gap in comparison with band gap-less graphene material. MoS₂ has a layered structure in which the interaction between adjacent S–Mo–S layers is van der Waals force, so the mechanical exfoliation method can be applied to peel off individual layers.¹ More importantly, MoS₂ is a semiconductor with a direct band gap of 1.8 eV for a single layer and an indirect band gap of 1.2 eV for a bulk material.^{2,3} Due to its semiconducting properties, MoS₂ has been used in electronic devices such as MoS₂ field effect transistors (FETs).^{4–6}

Mechanical exfoliation, often called as a scotch-tape method, is a simple method to achieve thin MoS₂ layer film on various substrates.⁷ In spite of the convenience of this method, there are also many limitation such as disability of positioning of MoS₂ pieces and complex fabrication process because of its small lateral size. To overcome

these problems, many researchers have developed other methods such as chemical vapor deposition (CVD) that allows the synthesis of large MoS₂ atomic films.^{8,9} We have also previously demonstrated that a large size, single layer MoS₂ film can be synthesized by the CVD method.¹⁰ However, a CVD-synthesized MoS₂ film has many grain boundaries because of rather randomly oriented domains throughout the synthesized MoS₂ film. At the boundary where different domains are merged, MoS₂ atomic structures are twisted and tilted. And these grain boundaries often degrade the electrical properties of MoS₂ films. Therefore, it is necessary to synthesize a large area MoS₂ atomic film with single domain configuration. One strategy for this is to choose a proper substrate which is a single crystal and has an atomic structure and lattice constant matched well with those of hexagonal-structured MoS₂ film.^{11–13}

In this study, we synthesized MoS₂ atomic films on various substrates by the CVD method. We chose three different substrates; SiO₂ as an amorphous substrate, Al₂O₃ as a hexagonal crystalline substrate with a lattice constant not well matched that of MoS₂ film, and GaN as a hexagonal crystalline substrate with a lattice constant well matched with that of MoS₂ film. We investigated the orientations

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of domains of MoS₂ atomic film on these three substrates. Our study may provide an insight as a route to synthesize large single layer and single domain MoS₂ film.

2. EXPERIMENTAL DETAILS

Figure 1 shows the schematic illustration of the CVD system to synthesize MoS₂ films in this study. During the MoS₂ synthesis, we employed the optimized conditions of temperature, pressure, and atmosphere. We placed MoO₃ powder (99.5% Aldrich) as a Mo precursor (~10 mg) at the center of quartz tube, and we placed sulfur powder (99.98% Aldrich) as an S precursor on the electric heater to vaporize sulfur. To heat MoO₃ and S independently, we equipped dual heating components. In this setup, MoO₃ was vaporized in the furnace (at ~700 °C) and S is vaporized by the electric heater (at ~200 °C). Different substrates (SiO₂, Al₂O₃, and GaN substrates) for MoS₂ synthesis were placed in a boat containing a MoO₃ powder source. During the synthesis, Ar gas was mixed with vaporized sulfur and flowed at 150 sccm into the furnace (temperature was set to ~700 °C). The synthesis of MoS₂ films was maintained for 5 min in the Ar gas environment, and then the furnace was cooled down at room temperature for 10 hours. With these, we successfully synthesized large-scale, single-layer MoS₂ films on the substrates.

GaN is deposited on Al₂O₃ substrate with a thickness of ~2 μm to be unaffected by the Al₂O₃ substrate. Al₂O₃ substrate and GaN substrate have the lattice constant of 4.76 Å and 3.18 Å, respectively, in comparison to the lattice constant of 3.17 Å of MoS₂ films.^{14–16}

The Raman spectroscopic measurements were performed with a commercial micro-Raman instrument (XperRam 200) which includes pumped solid state laser (wavelength of 532 nm). The Raman system is also equipped with a laser scanner which has a spatial resolution about 20 nm. Objective lens (Olympus, MPLFLN 40X, NA = 0.75) was used to focus the laser to about 1 μm spot size. The exposure time for each spectrum was 500 ms with an incident laser power about 2 mW.

3. RESULTS AND DISCUSSION

Raman spectroscopy has widely been used to study the vibrational properties of two-dimensional materials and

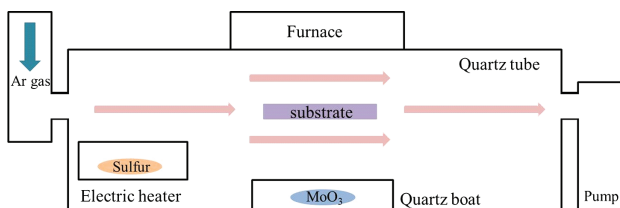


Fig. 1. Schematic illustration of the CVD setup to synthesize MoS₂ films.

to quantitatively determine their thickness.¹⁷ It has been reported that when single-layer single-domain MoS₂ film is synthesized by CVD method, it forms as triangular shape.^{8,9} Figure 2 shows Raman spectroscopic images over an area of single-layer single-domain triangular-shaped MoS₂ film that were synthesized on a SiO₂ substrate by the CVD method. The size of this triangular MoS₂ film is ~30 μm. The Raman spectra of the MoS₂ films are characterized by two major peaks. One is assigned as the E_{2g}¹ mode (that corresponds to the vibrational motion of Mo and S atoms in the *x-y* layered plane) and the A_{1g} mode (that corresponds to the vibrational motion of two S atoms along the *z*-axis of the unit cell) of hexagonal single-crystal MoS₂.^{18,19} The exact position of the peaks corresponding to the E_{2g}¹ and A_{1g} vibrational modes and the ratio of their intensities depend on the layer thickness of the MoS₂ samples.

From the Raman spectroscopic frequency images (Figs. 2(a) and (b)), we observed that the E_{2g}¹ peak and A_{1g} peak are positioned around 384 cm⁻¹ and 405 cm⁻¹. These peak positions ensure that the synthesized triangular film is indeed MoS₂ atomic film. Also we did not observe any significant deviation regarding the peak positions in the images of Figures 2(a) and (b), which means that uniform MoS₂ films were synthesized. In particular, the frequency difference between the two Raman peaks is about 21 cm⁻¹ (405 cm⁻¹ – 384 cm⁻¹), suggesting that the triangular MoS₂ films are single-layer thick MoS₂ atomic film. Figures 2(c) and (d) show Raman spectroscopic intensity images obtained at 384 cm⁻¹ (E_{2g}¹ peak) and 405 cm⁻¹ (A_{1g} peak). These images display uniform intensities at these two specific frequencies. It means that MoS₂ thin film has uniform thickness because the peak position will be changed when the thickness of MoS₂ is not uniform. We also observed some irregularity (defects) near the center

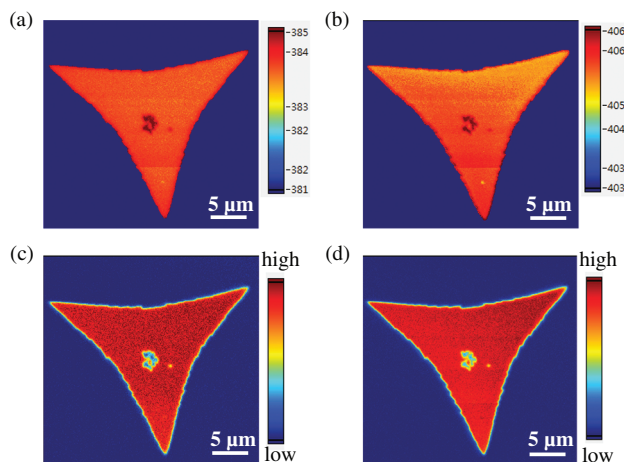


Fig. 2. (a, b) Raman spectroscopic frequency images that were obtained on a MoS₂ film synthesized on a SiO₂ substrate, indicating that the E_{2g}¹ mode peak and A_{1g} mode peak are positioned around (a) 384 cm⁻¹ and (b) 405 cm⁻¹. (c, d) Raman intensity images at fixed frequency of (a) 384 cm⁻¹ (E_{2g}¹ mode) and (b) 405 cm⁻¹ (A_{1g} mode).

of MoS₂ triangular film where there was no MoS₂ signal observed. It is likely that there was some nucleation which is composed of MoO₃ in these defects.

The results of Figure 2 are Raman spectroscopic images obtained on a MoS₂ film synthesized on a SiO₂ substrate which is amorphous. We also synthesized MoS₂ films on different substrates; Al₂O₃ and GaN which are a hexagonal structured single crystal. During the MoS₂ synthesis in the quartz tube in the CVD method, the vaporized Mo and S are combined and deposited on the substrate, therefore, the crystallinity, atomic structure, and lattice constant of the substrate are important factors. The Al₂O₃ and GaN have hexagonal atomic structure which is similar to the hexagonal structure of MoS₂. If the lattice constant of the substrate is matched well with that of MoS₂, then single domains of MoS₂ is likely to tend to be aligned with less grain boundaries. As mentioned before, the Al₂O₃ and GaN have the lattice constant of 4.76 Å and 3.18 Å,

respectively, in comparison to the lattice constant of 3.17 Å for MoS₂ films. So, the lattice constant of Al₂O₃ is not matched with that of MoS₂ whereas the lattice constant of GaN is matched well with that of MoS₂.

Figures 3(a)–(c) show the results of MoS₂ synthesis on SiO₂, Al₂O₃ and GaN substrate, respectively. Left images of Figure 3 are optical microscopic images and right plots are the relative angular orientation of the triangular MoS₂ individual films. For convenience, we marked dot-dashed, red-lined triangles to analyze the direction of the MoS₂ domains in the optical images. First, the results of Figure 3(a) (the case of SiO₂ substrate) indicate that there was no preference in the orientation angle. The right plot of Figure 3(a) clearly shows rather random distribution of orientation angles of MoS₂ triangular films. Here, zero degree was defined by an axis reference (marked in the left images of Fig. 3). This random orientation of MoS₂ triangular films is because the amorphous SiO₂ substrate

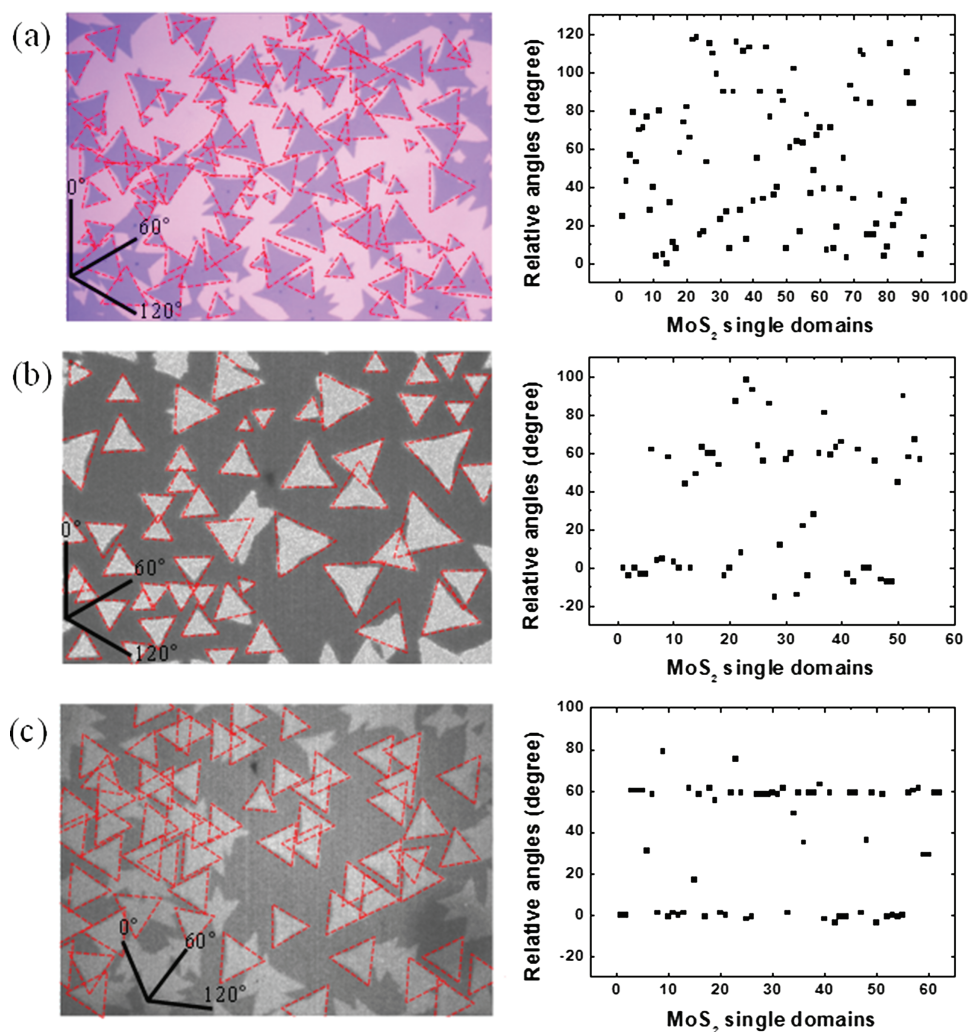


Fig. 3. (Left) Optical images and (right) relative angle analysis plot of the MoS₂ domains synthesized on (a) SiO₂, (b) Al₂O₃, and (c) GaN substrates. The insets in left images show the reference for the domain orientation direction. The right plots represent the relative orientation angles for the individual MoS₂ domains.

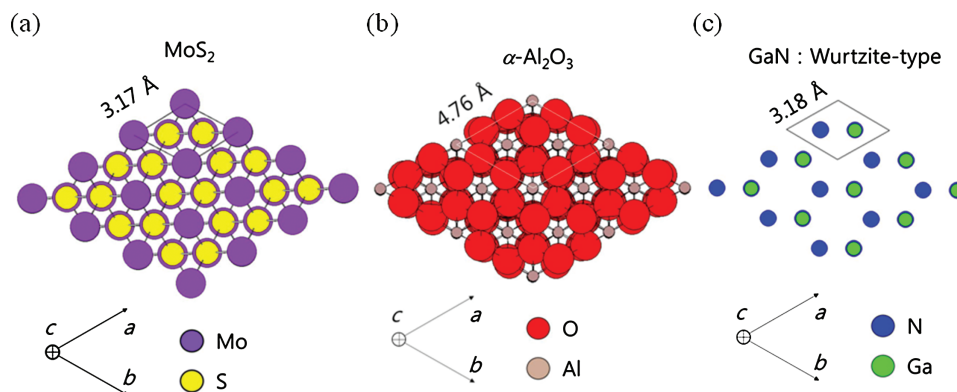


Fig. 4. Hexagonal atomic structures of (a) MoS₂, (b) Al₂O₃, and (c) GaN. The lattice constants are marked along *a*-axis of the unit cell (rhombus at the top of illustration).

has no crystal structure. The evaporated molybdenum and sulfur have no preferential growth alignment when they are synthesized on amorphous surface.

For the case of Al₂O₃ substrate as a hexagonal crystal with the lattice constant (4.76 Å) not matched with that (3.17 Å) of MoS₂ film (Fig. 3(b)), the domains of MoS₂ films had a tendency of alignment with the angle orientation of 60°, but the alignment was rather not perfect. Due to the hexagonal crystal structure of Al₂O₃, molybdenum and sulfur have preference to be deposited at particular site. However, because of the lattice strain caused by difference of lattice constant, MoS₂ domains were not aligned. In contrast, for the case of GaN substrate as a hexagonal crystal with a lattice constant (3.18 Å) matched well with that (3.17 Å) of MoS₂ film (Fig. 3(c)), the domains of MoS₂ films had a strong tendency of alignment with the angle orientation of 60°. This is because well matched lattice constant between GaN (3.18 Å) and MoS₂ (3.17 Å). This is because not only molybdenum and sulfur can be deposited on particular site at hexagonal atomic structure, but also the lattice-matched synthesis condition can reduce the lattice strain of MoS₂. Also, lattice-matched GaN can control the planar defect formation during the synthesis process.²⁰

In Figure 4, we present the in-plane atomic structure of MoS₂ (Fig. 4(a)), Al₂O₃ (Fig. 4(b)), and GaN (Fig. 4(c)). In Figure 4(a), purple circles and yellow circles are molybdenum and sulfur atoms, respectively. These atoms in MoS₂ are formed as a hexagonal atomic structure. In the hexagonal crystal structure, the *a*-axis and *b*-axis constants are equal, so we refer the lattice constant along the *a*-axis on a unit cell (at the top part of atomic structural illustration). Similarly, in Figure 4(b), red circles and light red circles are oxygen and aluminum atoms, respectively. These atoms in Al₂O₃ are also formed as a hexagonal atomic structure with the lattice constant 4.76 Å. This lattice constant of Al₂O₃ is not matched with that of MoS₂. In Figure 4(c), blue and green circles are nitride and gallium atoms, respectively. These components in GaN are

also formed as a hexagonal atomic structure, and particularly the lattice constant of GaN is matched well with that of MoS₂.

4. CONCLUSION

We synthesized single-layer MoS₂ atomic films on SiO₂, Al₂O₃, and GaN substrates by a chemical vapor deposition method. Here, SiO₂ as an amorphous, Al₂O₃ as a hexagonal crystal with a lattice constant not matched with that of MoS₂ film, and GaN as a hexagonal crystal with a lattice constant matched well with that of MoS₂ film. Then, we investigated the orientation properties of the domains of MoS₂ atomic films on these three substrates. We found that the domains of synthesized MoS₂ films on the GaN substrate were aligned better than SiO₂ or Al₂O₃ due to the similarities of the crystal structure and lattice constant of MoS₂. Our study may be helpful for researches towards a possible route to synthesize large size, single-layer and single-domain MoS₂ films.

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